



SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

LV8406T — Bi-CMOS IC 2ch Forward/Reverse Motor Driver

Overview

LV8406T is a 2-channel forward/reverse motor driver IC using D-MOS FET for output stage. As MOS circuit is used, it supports the PWM input. Its features are that the on resistance (0.75Ω typ) and current dissipation are low.

It also provides protection functions such as heat protection circuit and reduced voltage detection and is optimal for the motors that need high-current.

Functions

- 2-channel forward/reverse motor driver.
- Low power consumption.
- Low-ON resistance 0.75Ω .
- Built-in low voltage reset and thermal shutdown circuit.
- Four mode function forward/reverse, brake, stop.
- Built-in charge pump.

Specifications

Absolute Maximum Ratings at $T_a = 25^\circ\text{C}$, SGND = PGND = 0V

Parameter	Symbol	Conditions	Ratings	Unit
Power supply voltage (for load)	VM max	VM1, VM2	-0.5 to 16.0	V
Power supply voltage (for control)	V _{CC} max		-0.5 to 6.0	V
Output current	I _O max		1.4	A
Output peak current	I _O peak	$t \leq 10\text{ms}$	2.5	A
Input voltage	V _{IN} max		-0.5 to V _{CC} +0.5	V
Allowable power dissipation	Pd max	Mounted on a specified board*	3.1	W
Operating temperature	T _{opr}		-30 to +85	°C
Storage temperature	T _{stg}		-55 to +150	°C

* Specified board : 90mm × 90mm × 1.6mm, glass epoxy 2-layer board (2S0P).

Caution 1) Absolute maximum ratings represent the value which cannot be exceeded for any length of time.

Caution 2) Even when the device is used within the range of absolute maximum ratings, as a result of continuous usage under high temperature, high current, high voltage, or drastic temperature change, the reliability of the IC may be degraded. Please contact us for the further details.

■ Any and all SANYO Semiconductor Co.,Ltd. products described or contained herein are, with regard to "standard application", intended for the use as general electronics equipment. The products mentioned herein shall not be intended for use for any "special application" (medical equipment whose purpose is to sustain life, aerospace instrument, nuclear control device, burning appliances, transportation machine, traffic signal system, safety equipment etc.) that shall require extremely high level of reliability and can directly threaten human lives in case of failure or malfunction of the product or may cause harm to human bodies, nor shall they grant any guarantee thereof. If you should intend to use our products for new introduction or other application different from current conditions on the usage of automotive device, communication device, office equipment, industrial equipment etc. , please consult with us about usage condition (temperature, operation time etc.) prior to the intended use. If there is no consultation or inquiry before the intended use, our customer shall be solely responsible for the use.

■ Specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.

SANYO Semiconductor Co., Ltd.

<http://semicon.sanyo.com/en/network>

LV8406T

Allowable Operating Conditions at Ta = 25°C, SGND = PGND = 0V

Parameter	Symbol	Conditions	Ratings	Unit
Power supply voltage (VM pin)	VM		1.5 to 15.0	V
Power supply voltage (VCC pin)	VCC		2.8 to 5.5	V
Input signal voltage	VIN		0 to VCC	V
Input signal frequency	f max		200	kHz

Electrical Characteristics Ta = 25°C, VCC = 3.0V, VM = VS = 6.0V, SGND = PGND = 0V, unless otherwise specified.

Parameter	Symbol	Conditions	Remarks	Ratings			Unit
				min	typ	max	
Standby load current drain	IMO	EN = 0V	1			1.0	μA
Standby control current drain	ICO	EN = IN1 = IN2 = IN3 = IN4 = 0V	2			1.0	μA
Standby load current drain2	IMO2	VCC = 0V, VM = VS = 6V				1.0	μA
Operating control current drain	IC1	EN = 3V, with no load	3		0.85	1.2	mA
High-level input voltage	VIH	$2.7 \leq V_{CC} \leq 5.5V$		$0.6 \times V_{CC}$		VCC	V
Low-level input voltage	VIL	$2.7 \leq V_{CC} \leq 5.5V$		0		$0.2 \times V_{CC}$	V
High-level input current (EN1, EN2, IN1, IN2, IN3, IN4)	I _{IH1}	VIN = 3V	4		15	25	μA
Low-level input current (EN1, EN2, IN1, IN2, IN3, IN4)	I _{IL1}	VIN = 0V	4	-1.0			μA
Pull-down resistance value	RDN	EN1, EN2, IN1, IN2, IN3, IN4		100	200	400	kΩ
Charge pump voltage	VG	VCC + VS		8.5	9.0	9.5	V
Output ON resistance 1	RON1	Sum of top and bottom sides ON resistance.	5		0.75	1.2	Ω
Output ON resistance 2	RON2	Sum of top and bottom sides ON resistance. VCC = 2.8V	5		1.0	1.5	Ω
Low-voltage detection voltage	VCS	VCC pin voltage is monitored	6	2.15	2.30	2.45	V
Thermal shutdown temperature	Tth	Design guarantee value *	7	150	180	210	°C
Output block	Turn-on time	TPLH	8		0.2	0.4	μS
	Turn-off time	TPHL	8		0.2	0.4	μS

* : Design guarantee value and no measurement is preformed.

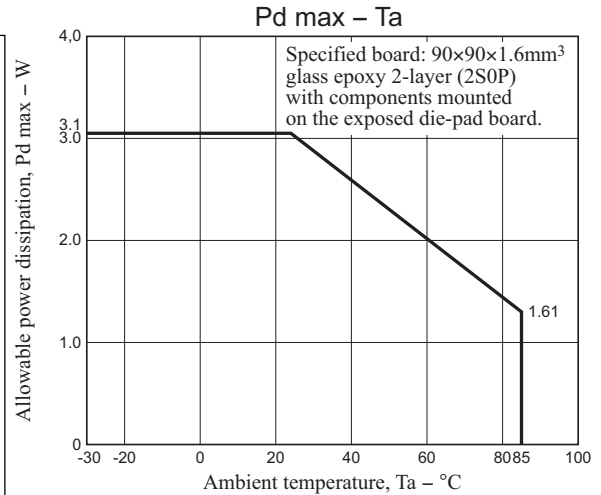
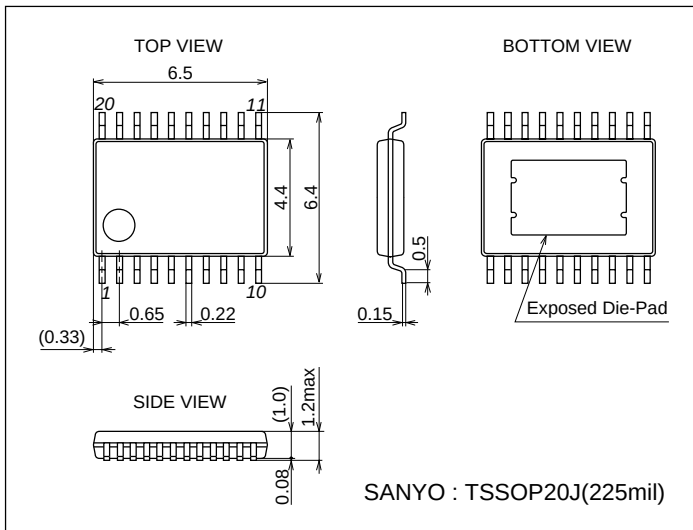
Remarks

1. Current consumption when output at the VM pin is off.
2. Current consumption when the VCC pin when in standby mode.
3. Current consumption at the VCC pin when EN is 3V (standby mode).
4. Pins EN1, 2, IN1, 2, 3, and 4 are all pulled down.
5. Sum of upper and lower saturation voltages of OUT pin divided by the current.
6. All power transistors are turned off if a low VCC condition is detected.
7. All output transistors are turned off if the thermal protection circuit is activated. They are turned on again as the temperature goes down.
8. Rising time from 10 to 90% and falling time from 90 to 10% are specified.

Package Dimensions

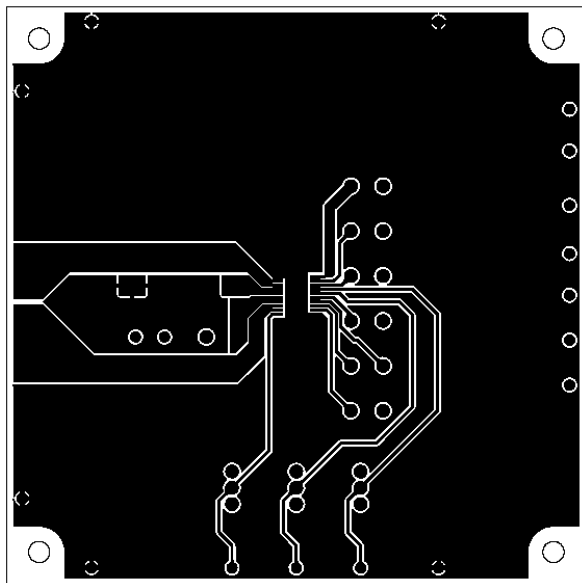
unit : mm (typ)

3279

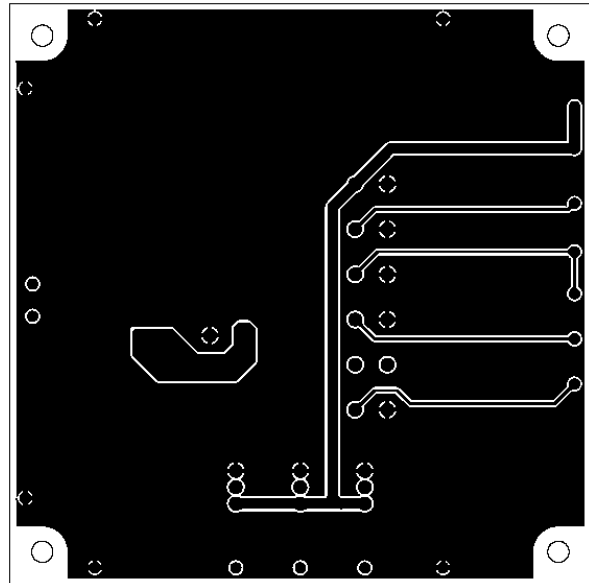


Substrate Specifications

Size : 90mm × 90mm × 1.6mm (2-layer substrate [2S0P])
 Material : Glass epoxy
 Copper wiring density : L1 = 95% / L2 = 95%



L1 : Copper wiring pattern diagram

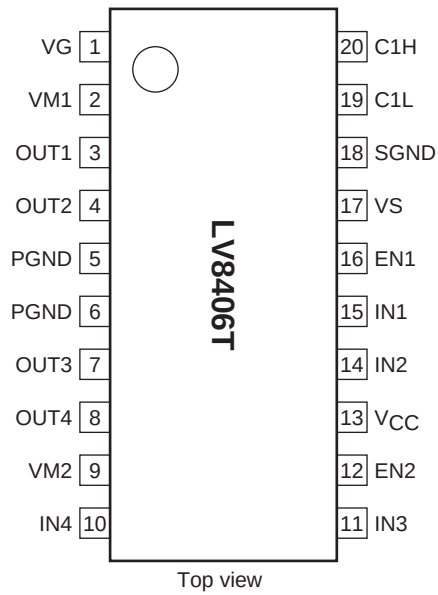


L2 : Copper wiring pattern diagram

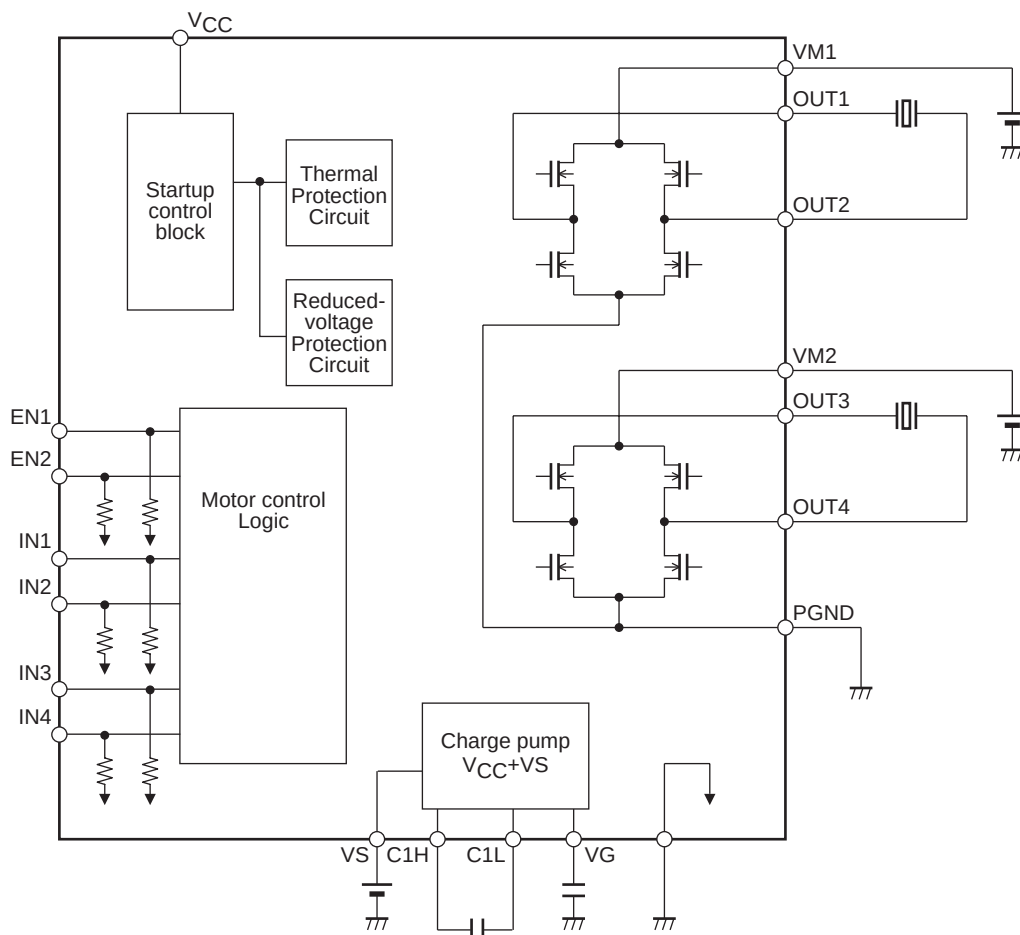
Cautions

- 1) The data for the case with the Exposed Die-Pad substrate mounted shows the values when 90% or more of the Exposed Die-Pad is wet.
- 2) For the set design, employ the derating design with sufficient margin.
 Stresses to be derated include the voltage, current, junction temperature, power loss, and mechanical stresses such as vibration, impact, and tension. Accordingly, the design must ensure these stresses to be as low or small as possible.
 The guideline for ordinary derating is shown below :
 (1)Maximum value 80% or less for the voltage rating
 (2)Maximum value 80% or less for the current rating
 (3)Maximum value 80% or less for the temperature rating
- 3) After the set design, be sure to verify the design with the actual product.
 Confirm the solder joint state and verify also the reliability of solder joint for the Exposed Die-Pad, etc.
 Any void or deterioration, if observed in the solder joint of these parts, causes deteriorated thermal conduction, possibly resulting in thermal destruction of IC.

Pin Assignment



Block Diagram



* Connect a kickback absorption capacitor as near as possible to the IC. Coil kickback may cause increase in VM line voltage, and a voltage exceeding the maximum rating may be applied momentarily to the IC, which results in deterioration or damage of the IC

* The pin VS is a terminal that supplies a source power supply of the charge pump circuit.
The charge pump voltage, $V_G = V_S + V_{CC}$ is generated.
Apply the high voltage of VM1 or VM2.

Truth Table

EN1 (EN2)	IN1 (IN3)	IN2 (IN4)	OUT1 (OUT3)	OUT2 (OUT4)	Charge pump	Mode
H	H	H	L	L	ON	Brake
	H	L	H	L		Forward
	L	H	L	H		Reverse
	L	L	Z	Z		Standby
L	-	-	Z	Z	OFF	All function stop

- : denotes a don't care value. Z : High-impedance

- In standby mode, consumption current serves as zero..

* All power transistors turn off and the motor stops driving when the IC is detected in low voltage or thermal protection mode.

Pin Functions

Pin No.	Pin name	Description	Equivalent circuit
20 1 17	C1H VG VS	Step-up capacitor connection pin. Charge pump source voltage supply pin.	
19	C1L	Step-up capacitor connection pin.	
16 12 15 14 11 10	EN1 EN2 IN1 IN2 IN3 IN4	Logic enable pin. (Pull-down resistor incorporated) Driver output switching.	
3 4 7 8	OUT1 OUT2 OUT3 OUT4	Driver output.	
2 9	VM1 VM2	Motor block power supply.	
13	VCC	Logic block power supply.	
18	SGND	Control block ground.	
5 6	PGND PGND	Driver block ground.	

- SANYO Semiconductor Co.,Ltd. assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein.
- SANYO Semiconductor Co.,Ltd. strives to supply high-quality high-reliability products, however, any and all semiconductor products fail or malfunction with some probability. It is possible that these probabilistic failures or malfunction could give rise to accidents or events that could endanger human lives, trouble that could give rise to smoke or fire, or accidents that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all SANYO Semiconductor Co.,Ltd. products described or contained herein are controlled under any of applicable local export control laws and regulations, such products may require the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written consent of SANYO Semiconductor Co.,Ltd.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the SANYO Semiconductor Co.,Ltd. product that you intend to use.
- Upon using the technical information or products described herein, neither warranty nor license shall be granted with regard to intellectual property rights or any other rights of SANYO Semiconductor Co.,Ltd. or any third party. SANYO Semiconductor Co.,Ltd. shall not be liable for any claim or suits with regard to a third party's intellectual property rights which has resulted from the use of the technical information and products mentioned above.

This catalog provides information as of November, 2011. Specifications and information herein are subject to change without notice.